

CoolMOS™ S7

600V CoolMOS™ SJ S7 Power Device

IPDQ60R010S7 enables the best price performance for low frequency switching applications. CoolMOS $^{\text{TM}}$ S7 boasts the lowest R_{DS(on)} values for a HV SJ MOSFET, with distinctive increase of energy efficiency.

CoolMOS™ S7 is optimized for "static switching" and high current applications. It is an ideal fit for solid state relay and circuit breaker designs as well as for line rectification in SMPS and inverter topologies.

Features

- CoolMOSTM S7 technology enables $10m\Omega$ $R_{DS(on)}$ in the smallest footprint
- Optimized price performance in low frequency switching applications
- · High pulse current capability
- Kelvin Source pin improves switching performance at high current
- QDPAK bottom side cooling package is MSL1 compliant, total Pb-free and suitable for standard PCB assembling flow, enabling simple system integration

Benefits

- Minimized conduction losses (eliminate / reduce heat sink)
- Increased system performance
- · More compact and easier design
- Lower BOM or/and TCO over prolonged life time

Compared to electromechanical devices:

- · Faster switching times
- · Higher reliability and longer system life time
- Shock & vibration resistance
- · No contact arcing, bouncing or degradation over life time

Potential applications

- Solid state relays and circuit breakers
- Line rectification in high power/performance applications e.g. Computing, Telecom, UPS and Solar

Product validation

Fully qualified according to JEDEC for Industrial Applications

Please note: The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate.

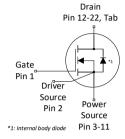
Table 1 Key Performance Parameters

Parameter	Value	Unit
R _{DS(on),max}	10	mΩ
$Q_{g,typ}$	318	nC
V _{SD}	0.82	V
Pulsed I _{SD} , I _{DS}	801	А

Type/Ordering Code	Package	Marking	Related Links
IPDQ60R010S7	PG-HDSOP-22	60R010S7	see Appendix A









Public

600V CoolMOS™ SJ S7 Power Device IPDQ60R010S7



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1 Maximum ratings

at T_i = 25°C, unless otherwise specified

Table 2 Maximum ratings

Cumhal	Values			11*4	Nata/TaskCanditian	
Symbol	Min.	Тур.	Мах.		Note/ Test Condition	
I _D	-	-	50	А	T _c =140°C Current is limited by T _{j max} = 150°C; Lower case temp does increase current capability	
I _{D,pulse}	-	-	801	А	T _c =25°C	
E_{AS}	-	-	616	mJ	I _D =6.3A; V _{DD} =50V; see table 10	
I _{AS}	-	-	6.3	Α	-	
dv/dt	-	-	20	V/ns	V _{DS} = 0V to 300V	
V_{GS}	-20	-	20	V	static	
V_{GS}	-30	-	30	V	AC (f>1 Hz)	
P_{tot}	-	-	694	W	<i>T</i> _C =25°C	
$T_{\rm stg}$	-55	-	150	°C	-	
$T_{\rm j}$	-55	-	150	°C	-	
$T_{\rm j}$	150	_	175	°C	≤50 h in the application lifetime	
-	-	-	n.a.	Ncm	-	
I _S	-	-	50	А	T _c =140°C Current is limited by T _{j max} = 150°C; Lower case temp does increase current capability	
I _{S,pulse}	-	-	801	А	T _c =25°C	
dv/dt	-	-	5	V/ns	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ ≤50A, $T_{\rm j}$ =25°C see table 8	
di _f /dt	-	-	1000	A/μs	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ ≤50A, $T_{\rm j}$ =25°C see table 8	
V _{ISO}	-	-	n.a.	٧	V _{rms} , T _C =25°C, <i>t</i> =1min	
	I _{D,pulse} E _{AS} I _{AS} dv/dt V _{GS} V _{GS} P _{tot} T _j T _j - I _S I _{S,pulse} dv/dt di _f /dt	Symbol Min. I_D - I_D	Symbol Min. Typ. I_D - - $I_{D,pulse}$ - - I_{AS} - - I_{AS} - - I_{AS} - - I_{C} - </td <td>Symbol Min. Typ. Max. I_D - - 50 I_D - - 801 I_D - - 616 I_D - - 6.3 I_D - - 6.3 I_D - - 20 I_D - - 20 I_D - - 20 I_D - - 20 I_D - - - 694 I_D - - - 150 I_D - - - 150 I_D - - - 175 I_D - - - - - - I_D -<td>Symbol Min. Typ. Max. Unit I_D - - 50 A $I_{D,pulse}$ - - 801 A I_{AS} - - 616 mJ I_{AS} - - 6.3 A I_{AS} - - 6.3 A I_{AS} - - 20 V/ns I_{CS} -20 - 20 V I_{CS} -30 - 30 V I_{CS} -30 - 30 V I_{CS} -55 - 150 °C I_{CS} -55 - 150 °C I_{CS} - - 175 °C I_{CS} - - - 175 °C I_{CS} - - - - 801 A I_{CS} - - - 801</td></td>	Symbol Min. Typ. Max. I_D - - 50 I_D - - 801 I_D - - 616 I_D - - 6.3 I_D - - 6.3 I_D - - 20 I_D - - 20 I_D - - 20 I_D - - 20 I_D - - - 694 I_D - - - 150 I_D - - - 150 I_D - - - 175 I_D - - - - - - I_D - - <td>Symbol Min. Typ. Max. Unit I_D - - 50 A $I_{D,pulse}$ - - 801 A I_{AS} - - 616 mJ I_{AS} - - 6.3 A I_{AS} - - 6.3 A I_{AS} - - 20 V/ns I_{CS} -20 - 20 V I_{CS} -30 - 30 V I_{CS} -30 - 30 V I_{CS} -55 - 150 °C I_{CS} -55 - 150 °C I_{CS} - - 175 °C I_{CS} - - - 175 °C I_{CS} - - - - 801 A I_{CS} - - - 801</td>	Symbol Min. Typ. Max. Unit I_D - - 50 A $I_{D,pulse}$ - - 801 A I_{AS} - - 616 mJ I_{AS} - - 6.3 A I_{AS} - - 6.3 A I_{AS} - - 20 V/ns I_{CS} -20 - 20 V I_{CS} -30 - 30 V I_{CS} -30 - 30 V I_{CS} -55 - 150 °C I_{CS} -55 - 150 °C I_{CS} - - 175 °C I_{CS} - - - 175 °C I_{CS} - - - - 801 A I_{CS} - - - 801	

 $^{^{1)}}$ Pulse width t_p limited by $T_{j,max}$

 $^{^{2)}\,\,}$ The dv/dt has to be limited by appropriate gate resistor

³⁾ Identical low side and high side switch



2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Symbol	Min.	Тур.	Мах.	Oille	Note/ Test Condition	
Thermal resistance, junction - case	R_{thJC}	-	-	0.18	°C/W	-	
Thermal resistance, junction - ambient	R_{thJA}	-	-	62	°C/W	device on PCB, minimal footprint	
Thermal resistance, junction - ambient for SMD version	R_{thJA}	-	45	55	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µ""m thickness) copper area. Tap exposed to air. PCB is vertical without air stream cooling.	
Soldering temperature, reflow soldering allowed	$T_{\rm sold}$	-	-	260	°C	reflow MSL1	



3 Electrical characteristics

at T_i=25°C, unless otherwise specified

Table 4 Static characteristics

For applications with applied blocking voltage >70% of the specified blocking voltage, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the

necessary technical support by Infineon

Darameter	Symphol		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/ Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	600	-	_	V	$V_{\rm GS}$ =0V, $I_{\rm D}$ =1mA	
Gate threshold voltage	$V_{(GS)th}$	3.5	4.0	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 3.08 \rm mA$	
Zero gate voltage drain current	I_{DSS}	-	- 80	8	μΑ	$V_{\rm DS}$ =600V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =25°C $V_{\rm DS}$ =600V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =150°C	
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V	
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	0.009 0.022	0.010	Ω	V_{GS} =12V, I_D =50A, T_j =25°C V_{GS} =12V, I_D =50A, T_j =150°C	
Gate resistance	R_{G}	-	0.45	_	Ω	<i>f</i> =1MHz, open drain	

Table 5 Dynamic characteristics

Darameter	Symbol Values				Unit	Note / Test Condition	
Parameter	Syllibot	Min.	Тур.	Мах.	Offic	Note/ Test Condition	
Input capacitance	C _{iss}	-	11986	-	pF	V _{GS} =0V, V _{DS} =300V, <i>f</i> =250kHz	
Output capacitance	Coss	-	188	-	pF	V _{GS} =0V, V _{DS} =300V, <i>f</i> =250kHz	
Effective output capacitance, energy related ⁴⁾	$C_{ m o(er)}$	-	644	-	pF	$V_{\rm GS}$ =0V, $V_{\rm DS}$ =0 to 300V	
Effective output capacitance, time related ⁵⁾	C _{o(tr)}	-	5717	-	pF	$I_{\rm D}$ =constant, $V_{\rm GS}$ =0V, $V_{\rm DS}$ =0 to 300V	
Output charge	$Q_{\rm oss}$	-	1714	-	nC	V _{GS} =0V, V _{DS} =0 to 300V	
Turn-on delay time	$t_{ m d(on)}$	-	50	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 9	
Rise time	t_{r}	-	5	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 9	
Turn-off delay time	$t_{\sf d(off)}$	-	180	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 9	
Fall time	$t_{ m f}$	-	9	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =50A, $R_{\rm G}$ =3 Ω ; see table 9	

 $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 300V

 $C_{\rm o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 300V



Table 6 Gate charge characteristics

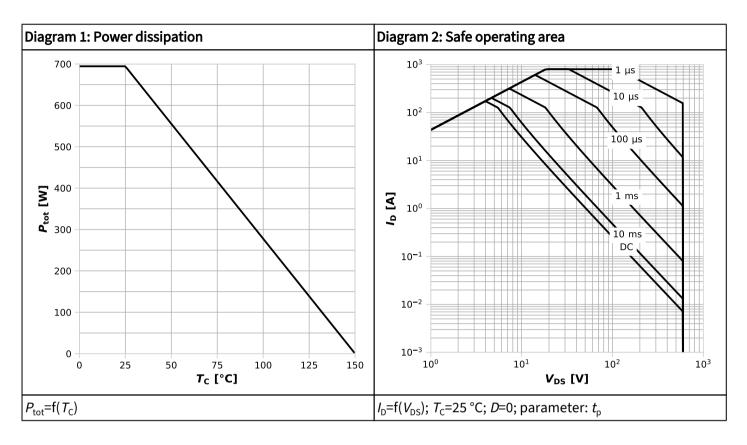
Parameter	Symbol	Values			Unit	Note/ Test Condition
	Syllibot	Min.	Тур.	Мах.	Offic	Note, rest condition
Gate to source charge	$Q_{ m gs}$	-	69	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V
Gate to drain charge	$Q_{ m gd}$	-	105	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V
Gate charge total	$Q_{ m g}$	-	318	-	nC	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V
Gate plateau voltage	$V_{ m plateau}$	-	5.7	-	V	$V_{\rm DD}$ =300V, $I_{\rm D}$ =50A, $V_{\rm GS}$ =0 to 12V

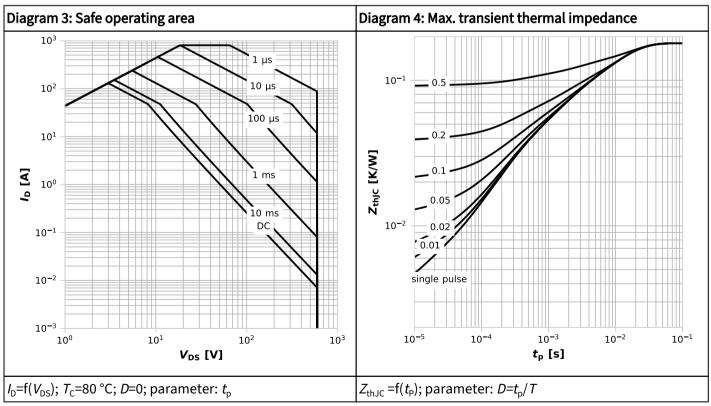
Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note/ Test Condition	
raiailletei	Symbol	Min.	Тур.	Мах.	Oilit	note/ rest condition	
Diode forward voltage	$V_{\rm SD}$	-	0.82	-	V	$V_{\rm GS}$ =0V, $I_{\rm F}$ =50A, $T_{\rm j}$ =25°C	
Reverse recovery time	t _{rr}	-	600	-	ns	$V_{\rm R}$ =300V, $I_{\rm F}$ =50A, d $i_{\rm F}$ /d t =100A/ μ s; see table 8	
Reverse recovery charge	$Q_{\rm rr}$	-	17	-	μC	$V_{\rm R}$ =300V, $I_{\rm F}$ =50A, d $i_{\rm F}$ /d t =100A/ μ s; see table 8	
Peak reverse recovery current	I _{rrm}	-	55	-	А	$V_{\rm R}$ =300V, $I_{\rm F}$ =50A, d $i_{\rm F}$ /d t =100A/ μ s; see table 8	

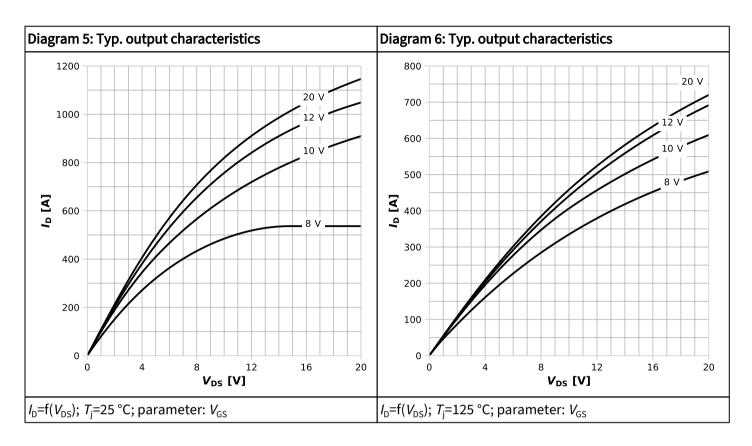


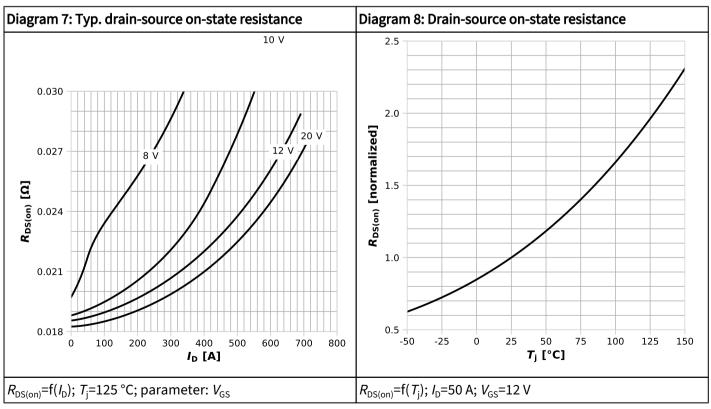
4 Electrical characteristics diagrams



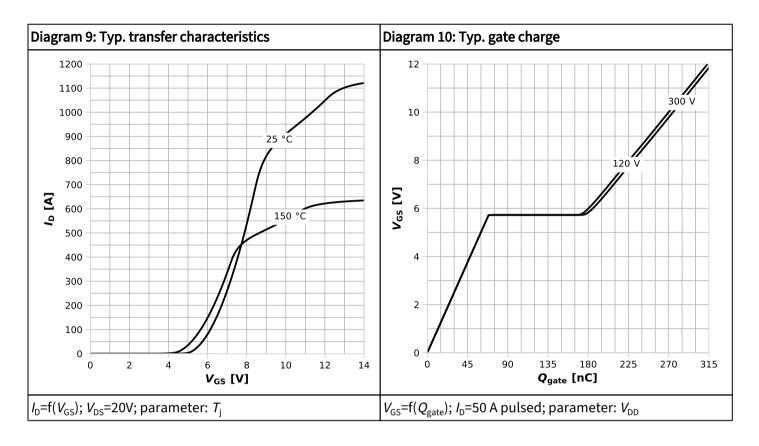


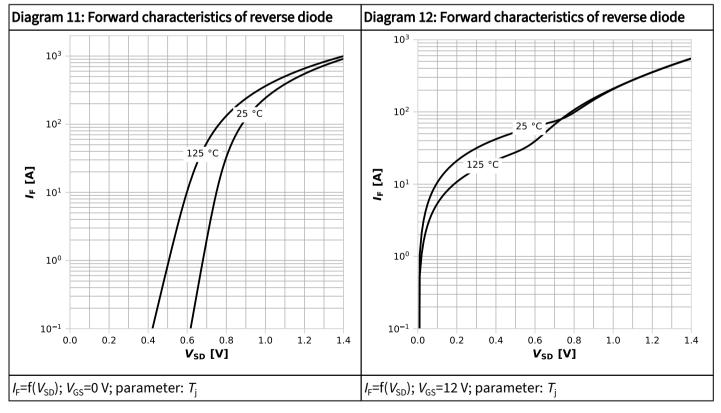




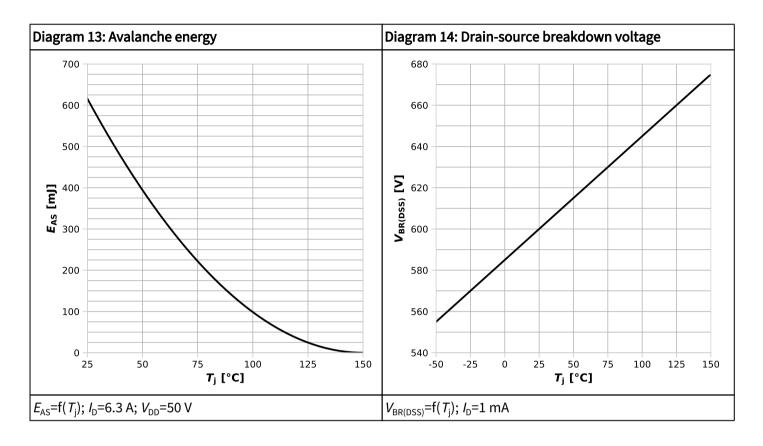


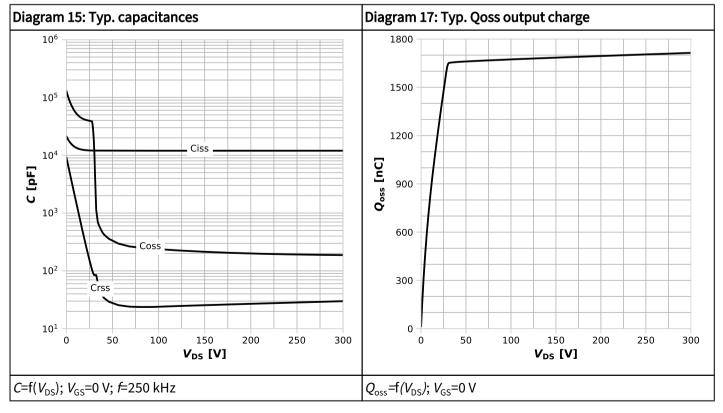














5 Test Circuits

Table 8 Diode characteristics

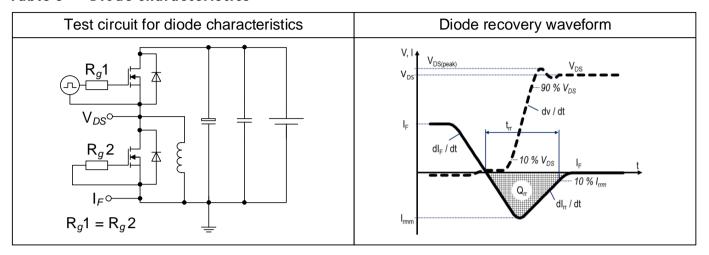


Table 9 Switching times (ss)

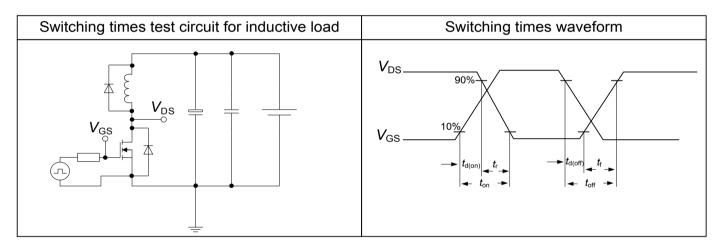
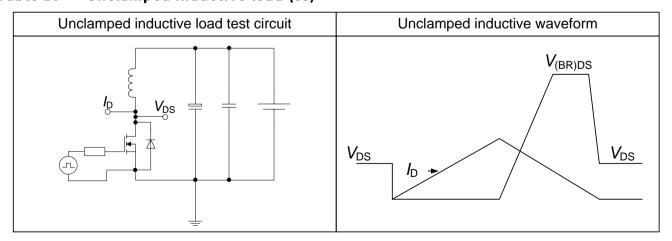


Table 10 Unclamped inductive load (ss)





6 Package Outlines

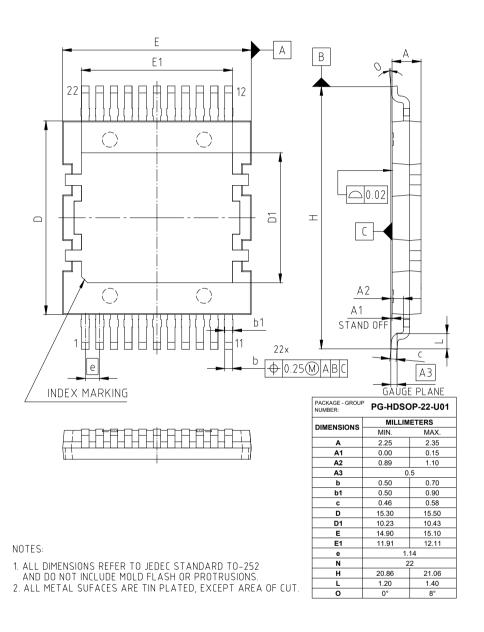


Figure 1 Outline PG-HDSOP-22, dimensions in mm



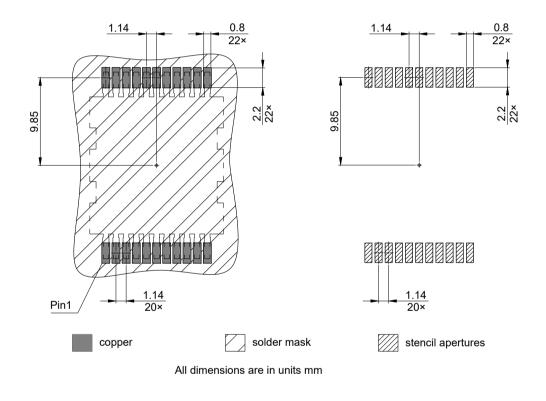


Figure 2 Outline PG-HDSOP-22, dimensions in mm



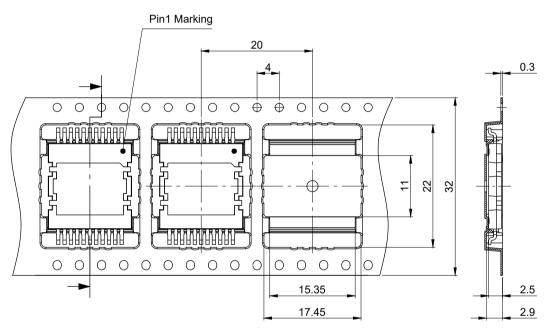


Figure 3 Outline PG-HDSOP-22, dimensions in mm



7 Appendix A

Table 11 Related Links

- IFX CoolMOS S7 Webpage
- IFX CoolMOS S7 application note
- IFX CoolMOS S7 simulation model
- IFX Design tools



Revision History

IPDO60R010S7

Revision 2024-05-24, Rev. 2.4

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2020-06-29	Release of final version
2.1	2021-10-25	Change of wording regarding breakdown voltage / cosmic ray
2.2	2023-11-06	Added footmark for pulsed drain current
2.3	2023-11-22	Additional maximum parameter for high current turn off added to datasheet for SSCB, SSR and motor start applications; Removed footmark from pulsed drain current
2.4	2024-05-24	Removed high current turn-off parameter limitation, Adaption of Transfer curve, Output characteristics and drain-source on-state resistance

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